

# **RF110**

## **2400 MHz ISM Band Power Amplifier**

### **Data Sheet**

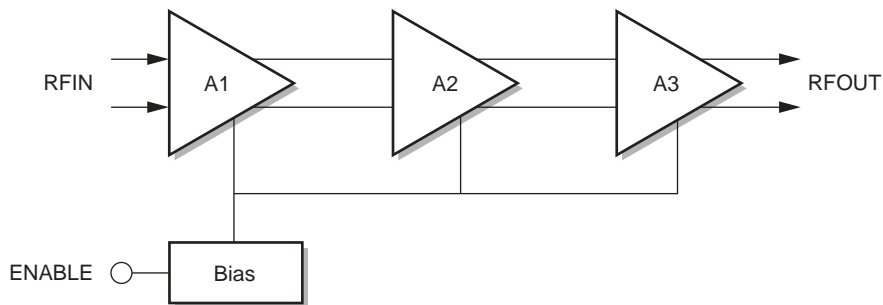


## RF110

### *2400 MHz ISM Band Power Amplifier*

The RF110 is a three-stage class AB-type power amplifier for 2400–2483.5 MHz Industrial, Scientific, Medical (ISM) band applications. It delivers output power proportional to the input signal power, making it ideal for applications with smoothlinearity requirements.

#### Functional Block Diagram



#### Distinguishing Features

- ◆ Class AB-type RF power amplifier
- ◆ Differential inputs and outputs
- ◆ 100 mW peak envelope output power
- ◆ Very fast settling from standby mode to active mode
- ◆ Efficient high output power operation
- ◆ Requires few external components
- ◆ Low power sleep mode
- ◆ 20-pin TSSOP package

#### Applications

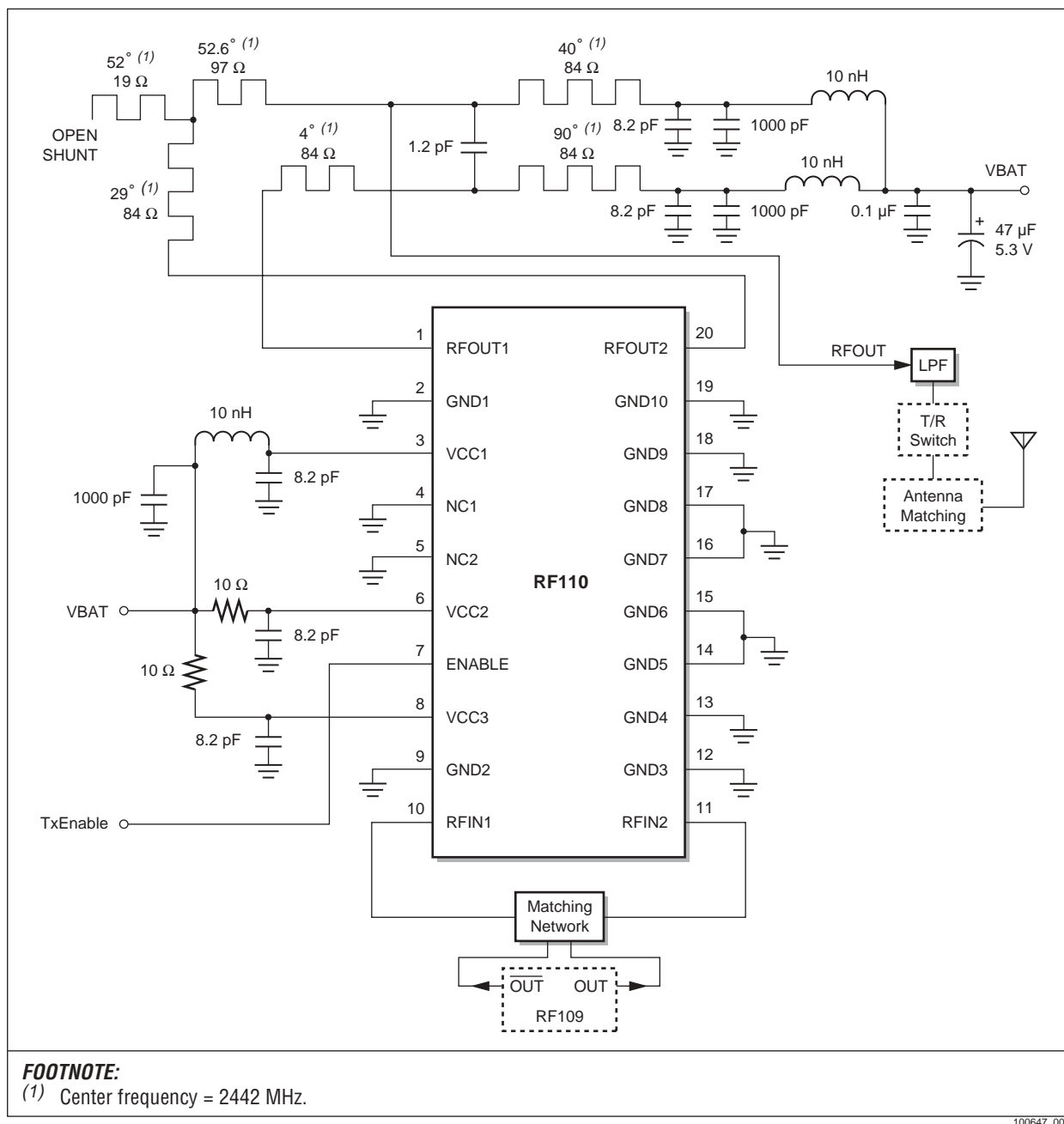
- ◆ Direct sequence spread spectrum systems
- ◆ Frequency hopping spread spectrum systems
- ◆ Wireless LANs
- ◆ Wireless modems
- ◆ Wireless security
- ◆ Inventory control systems
- ◆ Cordless telephones
- ◆ Remote monitoring



## Conexant

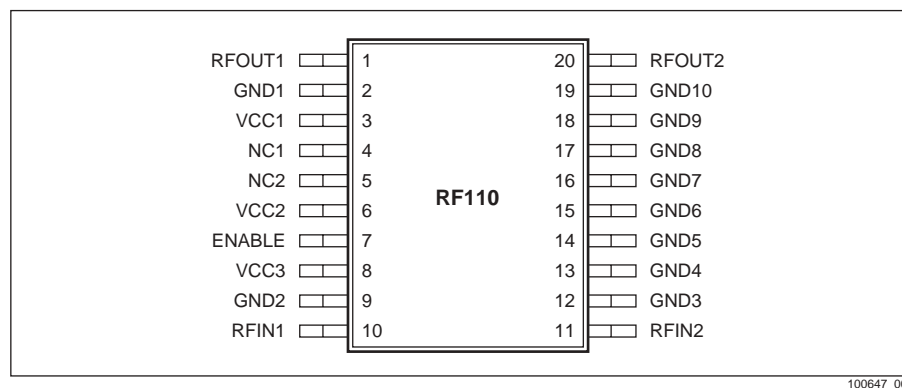
1

**FOOTNOTE:**  
(1) Center frequency = 2442 MHz.



The RF110 is operational in the 2400 MHz ISM band with supply voltage ranging from 3.0V to 4.5V. It is available in a small 20-pin TSSOP package, shown in [Figure 2](#).

**Figure 2. RF110 Pin Signals — 20-Pin TSSOP**



## Recommendations on Layout and Implementation

### Matching

An input matching network and an output matching network are required for maximum power gain.

The output matching network must provide the optimum load resistance to the RF110 outputs as well as convert the differential signals to a single-ended signal into a 50  $\Omega$  load. The output matching network should present a differential impedance of approximately 59-j10  $\Omega$  to the output of the RF110, with a 180° phase difference between the two branches.

The values of the matching network components depend on layout, Printed Wire Board (PWB) material and dimensions.

### Bypassing

All Vcc pins should have proper bypassing. The decoupling capacitors should be placed very close to the pins.

A bypass capacitor of 8.2 pF and a decoupling capacitor of 1 nF are recommended. Due to layout variations, the optimum value of the capacitor may vary.

### General Grounding Requirements

All ground pins should have minimum trace inductance to ground. If a ground plane cannot be provided right at the pins, the vias to ground plane should be placed as close to the pins as possible. There should be one via for each ground pin, unless otherwise specified. If the ground plane is at the bottom layer, two vias per pin in parallel may be required.

Pins 14–15 and 16–17 are recommended to be isolated from the top layer ground.

Pins 2, 9, 12, and 19 are recommended to be tied together on the top layer isolated from the top layer ground.

NC pins are not used in the circuit and should be connected to ground as shown in [Figure 1](#).

## ESD Sensitivity

The RF110 is a static-sensitive electronic device. Do not operate or store near strong electrostatic fields. Take proper Electrostatic Discharge (ESD) precautions.

## Interface Description

Table 1 describes the pin signals for the RF110.

**Table 1. Pin Signal Descriptions**

Pin No.	Name	Description
1	RFOUT1	Amplifier positive RF output
2	GND1	Ground
3	VCC1	Power supply (positive)
4	NC1	No connect. Recommended to connect to ground.
5	NC2	No connect. Recommended to connect to ground.
6	VCC2	Power supply (positive)
7	ENABLE	Amplifier enable (active high)
8	VCC3	Power supply (positive)
9	GND2	Ground
10	RFIN1	Amplifier positive RF input
11	RFIN2	Amplifier negative RF input
12	GND3	Ground
13	GND4	Ground
14	GND5	Ground
15	GND6	Ground
16	GND7	Ground
17	GND8	Ground
18	GND9	Ground
19	GND10	Ground
20	RFOUT2	Amplifier negative RF output

## Specifications

Table 2 lists the absolute maximum ratings for the RF110. Table 3 lists the electrical specifications for the RF110.

**Table 2. Absolute Maximum Ratings**

Parameter	Minimum	Maximum	Unit
Supply voltage (V <sub>CC</sub> ) <sup>(1)</sup>		+5	V
Input voltage range <sup>(1)</sup>	GND	V <sub>CC</sub>	V
Power dissipation at high output power mode		700	mW
Ambient operating temperature (T <sub>A</sub> )	−10	+70	°C
Storage temperature	−40	+125	°C
<b>FOOTNOTE:</b> <sup>(1)</sup> Voltages are referenced to GND.			

**Table 3. RF110 Electrical Specifications**

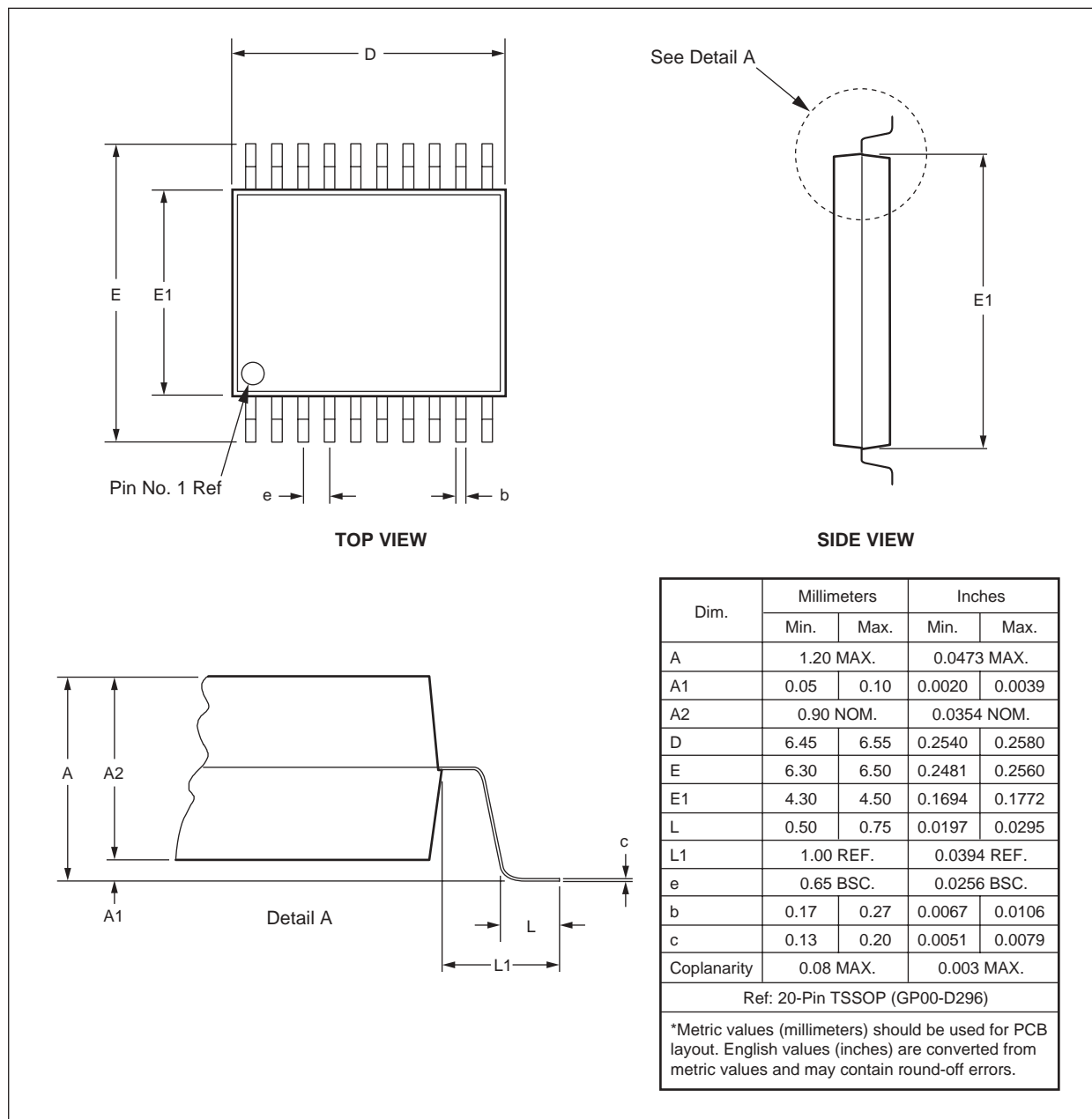
Parameter	Minimum	Typical	Maximum	Units
Operating power supply range <sup>(1)</sup>	3.0	3.6	4.5	V
Gain variation vs. frequency (2400–2500 MHz)		±0.6	±1.5	dB
Peak Envelope output Power (PEP) <sup>(2), (3)</sup>	17.5	20	22.5	dBm
RF small signal gain <sup>(4)</sup>		25.5		dB
Total supply current: Output power = 20 dBm PEP <sup>(2), (3)</sup> = 10 dBm PEP <sup>(2), (5)</sup> = 0 dBm PEP <sup>(2), (6)</sup> Standby <sup>(7)</sup>		120 100 95 < 10		mA mA mA μA
IM3: PEP = 21 dBm <sup>(2), (3)</sup>		−21	−16	dBc
Output VSWR for unconditional stability			10:1	—
RF output-to-input isolation @ 2450 MHz		50		dB
RF input impedance (differential)		70 + j20		Ω
RF output impedance (differential)		52 − j14		Ω
P1 dBm compression point <sup>(4)</sup>	−11	−8		dBm
V <sub>IH</sub> for ENABLE	1.9			V
V <sub>IL</sub> for ENABLE			0.8	V
I <sub>IH</sub> for ENABLE		10	60	μA
I <sub>IL</sub> for ENABLE	−20	−1		μA
<b>FOOTNOTE:</b> <sup>(1)</sup> The specifications in Table 3 are guaranteed at a supply voltage of 3.6 VDC and T <sub>a</sub> = 25 °C. <sup>(2)</sup> All PEP specifications are for two input sinusoids at 2440 MHz and 2450 MHz. PEP is calculated from the average power assuming a peak-to-average ratio of 3 dB. Output power loss due to the recommended output-matching network is included in the values in Table 3. <sup>(3)</sup> Input PEP = −3 dBm (differential). (Under this condition, RF110 output power is compressing. The output peak-to-average ratio is approximately 2 dB.) <sup>(4)</sup> Single sinusoidal input. <sup>(5)</sup> Input PEP = −15 dBm (differential). <sup>(6)</sup> Input PEP = −25 dBm (differential). <sup>(7)</sup> When ENABLE (pin 7) is low.				



## Device Dimensions

Package dimensions for the RF110 are given in [Figure 3](#).

**Figure 3. Package Dimensions — 20-Pin TSSOP**



100647\_004



## Ordering Information

Model Number	Package	Operating Temperature
RF-110-12	—	—

## Revision History

Revision	Level	Date	Description
A		Jan. 19, 2000	Initial release
B		August 26, 2002	Minor changes

© 2002, Conexant Systems, Inc.  
All Rights Reserved.

Information in this document is provided in connection with Conexant Systems, Inc. ("Conexant") products. These materials are provided by Conexant as a service to its customers and may be used for informational purposes only. Conexant assumes no responsibility for errors or omissions in these materials. Conexant may make changes to specifications and product descriptions at any time, without notice. Conexant makes no commitment to update the information and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to its specifications and product descriptions.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Conexant's Terms and Conditions of Sale for such products, Conexant assumes no liability whatsoever.

THESE MATERIALS ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, EITHER EXPRESS OR IMPLIED, RELATING TO SALE AND/OR USE OF CONEXANT PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, CONSEQUENTIAL OR INCIDENTAL DAMAGES, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. CONEXANT FURTHER DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. CONEXANT SHALL NOT BE LIABLE FOR ANY SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS, WHICH MAY RESULT FROM THE USE OF THESE MATERIALS.

Conexant products are not intended for use in medical, lifesaving or life sustaining applications. Conexant customers using or selling Conexant products for use in such applications do so at their own risk and agree to fully indemnify Conexant for any damages resulting from such improper use or sale.

The following are trademarks of Conexant Systems, Inc.: Conexant™, the Conexant C symbol, and "What's Next in Communications Technologies"™. Product names or services listed in this publication are for identification purposes only, and may be trademarks of third parties. Third-party brands and names are the property of their respective owners.

For additional disclaimer information, please consult Conexant's Legal Information posted at [www.conexant.com](http://www.conexant.com) which is incorporated by reference.

**Reader Response:** Conexant strives to produce quality documentation and welcomes your feedback. Please send comments and suggestions to [conexant.tech.pubs@conexant.com](mailto:conexant.tech.pubs@conexant.com). For technical questions, contact your local Conexant sales office or field applications engineer.

[www.conexant.com](http://www.conexant.com)

General Information:

U.S. and Canada: (800) 854-8099

International: (949) 483-6996

Headquarters – Newport Beach

4311 Jamboree Rd.

Newport Beach, CA. 92660-3007



**CONEXANT™**

*What's next in communications technologies*